

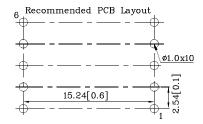


### **Features**

- Low power consumption
- Robust package
- I.C. Compatible
- Standard configuration: Gray face w/ white segments
- Optional black face provides superior color contrast
- RoHS Compliant

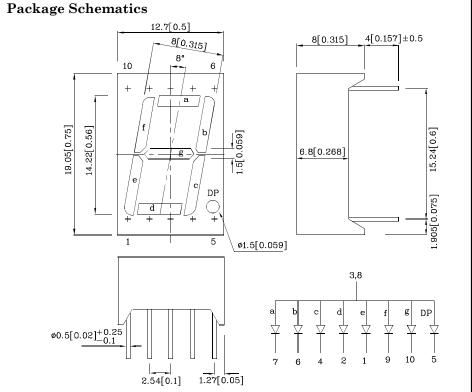








## ATTENTION OBSERVE PRECAUTIONS FOR HANDLING ELECTROSTATIC DISCHARGE SENSITIVE DEVICES



- 1. All dimensions are in millimeters (inches), Tolerance is  $\pm 0.25 (0.01")$  unless otherwise noted.
- 2. Specifications are subject to change without notice.

Absolute Maximum Ratings (T <sub>A</sub> =25°C)			
$V_{\rm R}$	5	V	
$I_{\mathrm{F}}$	30	mA	
$i_{\mathrm{FS}}$	155	mA	
$P_D$	75	mW	
$T_{A}$	-40 ~ +85	°C	
Tstg	-40 ~ +85		
e 260°C For 3-5 Seconds			
	$I_{F}$ $i_{FS}$ $P_{D}$ $T_{A}$ $Tstg$	$\begin{array}{cccccccccccccccccccccccccccccccccccc$	

A Relative Humidity between 40% and 60% is recommended in ESD-protected work areas to reduce static build up during assembly process (Reference JEDEC/JESD625-A and JEDEC/J-STD-033)

Operating Characteristics (T <sub>A</sub> =25°C)		Red (GaAlAs)	Unit
Forward Voltage (Typ.) (I <sub>F</sub> =10mA)	$V_{\mathrm{F}}$	1.8	V
Forward Voltage (Max.) (I <sub>F</sub> =10mA)	$V_{\mathrm{F}}$	2.3	V
Reverse Current (Max.) (V <sub>R</sub> =5V)	$I_R$	10	μА
Wavelength of Peak Emission CIE127-2007* (Typ.) (I <sub>F</sub> =10mA)	λР	655*	nm
Wavelength of Dominant Emission CIE127-2007* (Typ.) (I <sub>F</sub> =10mA)	λD	640*	nm
Spectral Line Full Width At Half-Maximum (Typ.) (I <sub>F</sub> =10mA)	$\triangle \lambda$	20	nm
Capacitance (Typ.) (V <sub>F</sub> =0V, f=1MHz)	С	45	pF

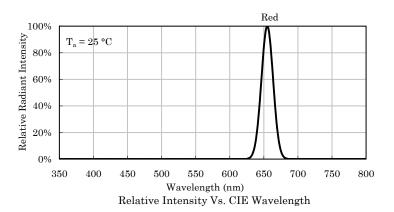
			Luminous Intensity	Wavelength	
Part	Emitting	Emitting	CIE127-2007*	CIE127-2007*	Diti
Number	$\operatorname{Color}$	Material	$(I_F=10mA)$	nm	Description
			ucd	$\lambda P$	

			min.	typ.		
XDMR14A	Red	GaAlAs	14000 5600*	33990 9990*	655*	Common Anode, Rt. Hand Decimal.

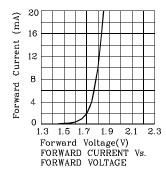
<sup>\*</sup>Luminous intensity value and wavelength are in accordance with CIE127-2007 standards. Feb 22,2019

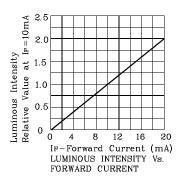
XDSA0219 V10-X Layout: Maggie

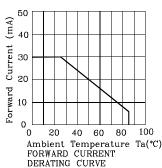


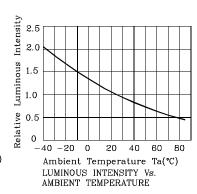


### ❖ Red

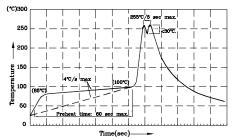








Wave Soldering Profile for Thru-Hole Products (Pb-Free Components)



- Notes:

  1. Recommend pre—heat temperature of 105°C or less (as measured thermocouple attached to the LED pins) prior to immersion in the wave with a maximum solder bath temperature of 260°C

  2. Peak wave soldering temperature between 245°C ~ 255°C for 3 sec
- 2.Peak wave soldering temperature between 245°C ~ 255°C for 3 secmax).
  3.Do not apply stress to the epoxy resin while the temperature is all 4.Fixtures should not incur stress on the component when mounting during soldering process.
  5.SAC 305 solder alloy is recommended.
  6.No more than one wave soldering pass.
  7.During wave soldering, the PCB top-surface temperature should be kept below 105°C.

### Remarks:

If special sorting is required (e.g. binning based on forward voltage, luminous intensity / luminous flux, or wavelength),

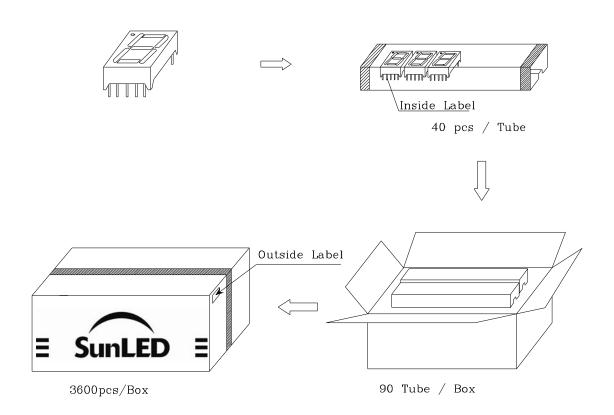
the typical accuracy of the sorting process is as follows:

- 1. Wavelength: +/-1nm
- 2. Luminous Intensity / Luminous Flux: +/-15%
- 3. Forward Voltage: +/-0.1V

Note: Accuracy may depend on the sorting parameters.



# PACKING & LABEL SPECIFICATIONS





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- 7. Additional technical notes are available at <a href="https://www.SunLEDusa.com/TechnicalNotes.asp">https://www.SunLEDusa.com/TechnicalNotes.asp</a>

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